

High-Voltage Liquid Crystal Shutter Driver

Features

- · Logic-selectable Output Voltage
- · 100 nF Drive Capability
- 90 V_{P-P} Maximum Output Voltage
- 25 µs Response Time

Applications

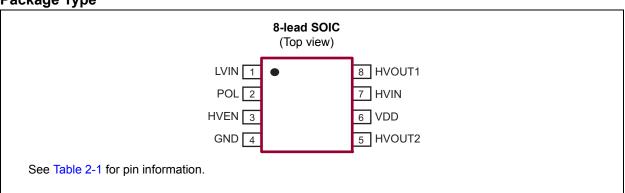
· Liquid Crystal Shutter

General Description

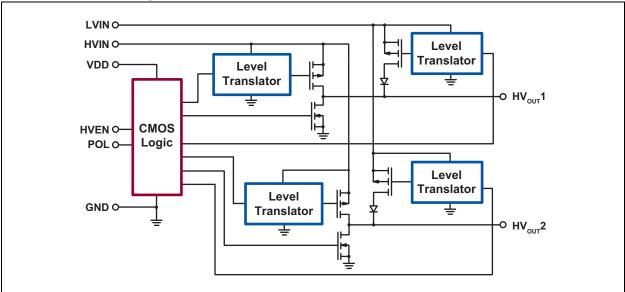
The HV508 is a 45V liquid crystal shutter driver in an 8-lead SOIC surface-mount package. It is composed of two outputs that provide square waves of opposite phases. The liquid crystal shutter is connected between the two outputs. Its equivalent load can be modeled as a minimum of 1 $M\Omega$ resistor in parallel with a maximum of 0.1 uF capacitor.

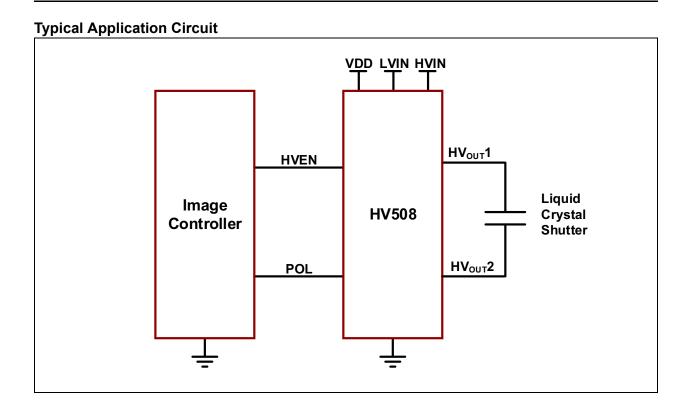
The HV508 has three input supply voltages—HV $_{IN}$, LV $_{IN}$ and V $_{DD}$. The output amplitude is either LV $_{IN}$ or HV $_{IN}$. A logic high on the HV $_{EN}$ input sets the output to operate from the HV $_{EN}$ input sets the output to operate from the HV $_{EN}$ input sets the output to operate from the LV $_{IN}$ supply. The output frequency is determined by the logic input frequency applied to the POL input.

Package Type



Functional Block Diagram





1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings†

High-voltage Input, HV _{IN}	+60V
Low-voltage Input, LV _{IN}	
Logic Supply voltage, V _{DD}	
Operating Ambient Temperature, T _A	
Storage Temperature, T _S	
Power Dissipation (Note 1):	
8-lead SOIC	700 mW

† Notice: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability.

Note 1: For operation above 25°C ambient, derate linearly at 6 mW/°C.

RECOMMENDED OPERATING CONDITIONS

Parameter	Sym.	Min.	Тур.	Max.	Unit	Conditions
Logic Supply Voltage	V_{DD}	5	_	10	V	
Low-output Supply Voltage	LV _{IN}	3	_	6	V	
High-output Supply Voltage	H_{VIN}	5	_	45	V	
Logic Input Voltage Low	V_{IL}	0	_	0.3 V _{DD}	V	
Logic Input Voltage High	V _{IH}	0.7 V _{DD}	_	V_{DD}	>	
Ambient Temperature	T _A	- 5	_	+60	Ô	

DC ELECTRICAL CHARACTERISTICS

Electrical Specifications: Over operating supply voltages; $T_A = -5^{\circ}C$ to +60°C unless otherwise indicated.								
Parameter	Sym.	Min.	Тур.	Max.	Unit	Conditions		
HV _{IN} Quiescent Current	I _{HVQ}	_	_	10	μA			
LV _{IN} Quiescent Current	I_{LVQ}	_	_	10	μA			
V _{DD} Quiescent Current	I_{DDQ}	_	_	10	μA			
HV _{IN} Operating Current	I _{HV}	_		2.8	mA	POL = 100 Hz, HV _{EN} = high, T_A = 25°C, Load = 1 M Ω in parallel with 0.1 μ F between HV _{OUT} 1 and HV _{OUT} 2		
LV _{IN} Operating Current	I _{LV}	_	_	380	μΑ	POL = 100 Hz, HV _{EN} = low, T_A = 25°C, Load = 1 MΩ in parallel with 0.1 μF between HV _{OUT} 1 and HV _{OUT} 2		
Logic Input Current Low	I _{IL}	– 5		_	μΑ			
Logic Input Current High	I _{IH}	_	_	5	μA			
Output Capacitive Load	C _{LOAD}	0	_	0.25	μF	C_{LOAD} in parallel with a 1 M Ω resistor (Note 1)		

Note 1: The device can operate continuously in this range without damage. AC limits are not implemented.

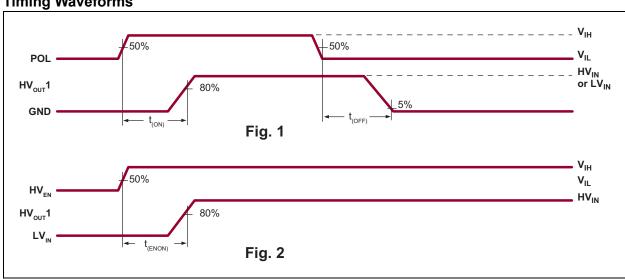
AC ELECTRICAL CHARACTERISTICS

Electrical Specifications: HV _{IN}	Electrical Specifications: $HV_{IN} = 45V$, $LV_{IN} = 6V$, $V_{DD} = 5V$, and $T_A = -5^{\circ}C$ to $+60^{\circ}C$.								
Parameter	Sym.	Min.	Тур.	Max.	Unit	Conditions			
POL Input Frequency	f _{POL}	0	_	100	Hz				
Turn-on Time when High-voltage is Enabled	t _{HV(ON)}		_	16	μs	Load = 1 M Ω in parallel with 0.1 µF between HV _{OUT} 1 and			
Turn-off Time when high-voltage is Enabled	t _{HV(OFF)}		_	16	μs	HV_{OUT} 2, HV_{EN} = high, outputs rise to HV_{IN} (See Fig.1 in Timing Waveforms .)			
Turn-on time when High-voltage is Disabled	t _{LV(ON)}	_	_	40	μs	Load = 1 MΩ in parallel with 0.1 μ F between HV _{OUT} 1 and HV _{OUT} 2,			
Turn-off time when High-voltage is Disabled	t _{LV(OFF)}	l		6	μs	HV _{EN} = low, outputs rise to HV _{IN} (See Fig.1 in Timing Waveforms .)			
Turn-on time from HV _{EN} to HV _{OUT}	t _{EN(ON)}	_	_	25	μs	Load = 1 M Ω in parallel with 0.1 μ F between HV _{OUT} 1 and HV _{OUT} 2 (See Fig.2 in Timing Waveforms .)			

TEMPERATURE SPECIFICATIONS

Parameter	Sym.	Min.	Тур.	Max.	Unit	Conditions			
TEMPERATURE RANGE									
Operating Ambient Temperature	T _A	-5	_	+60	°C				
Storage Temperature	T _S	-65	_	+150	°C				
PACKAGE THERMAL RESISTANCE									
8-lead SOIC	θ_{JA}	_	101	_	°C/W				

Timing Waveforms



HV508

2.0 PIN DESCRIPTION

The details on the pins of HV508 are listed on Table 2-1. Refer to **Package Type** for the location of pins.

TABLE 2-1: PIN FUNCTION TABLE

Pin Number	Pin Name	Description
1	LVIN	Low Voltage Supply
2	POL	Polarity
3	HVEN	High Voltage Enable
4	GND	Ground
5	HVOUT2	High Voltage Output Channel 2
6	VDD	Logic Voltage Supply
7	HVIN	High Voltage Supply
8	HVOUT1	High Voltage Output Channel 1

3.0 FUNCTIONAL DESCRIPTION

Follow the steps in Table 3-1 to power up and power down the HV508.

TABLE 3-1: POWER-UP AND POWER-DOWN SEQUENCE

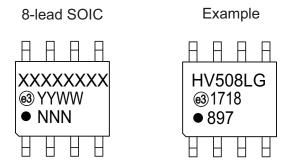
	Power-up	Power-down Power-down			
Step	Description	Step	Description		
1	Connect ground.	1	Remove LV _{IN.}		
2	Apply V _{DD} .	2	Remove H _{VIN} .		
3	Connect logic Inputs.	2	Remove all logic inputs.		
4	Connect HV _{IN.}	3	Remove V _{DD} .		
5	Connect LV _{IN.}	4	Disconnect ground.		

TABLE 3-2: TRUTH FUNCTION TABLE

HV _{EN}	POL	HV _{OUT} 1	HV _{OUT} 2
Н	Н	HV _{IN}	GND
Н	L	GND	HV _{IN}
L	Н	LV _{IN}	GND
L	L	GND	LV _{IN}

4.0 PACKAGE MARKING INFORMATION

4.1 Packaging Information

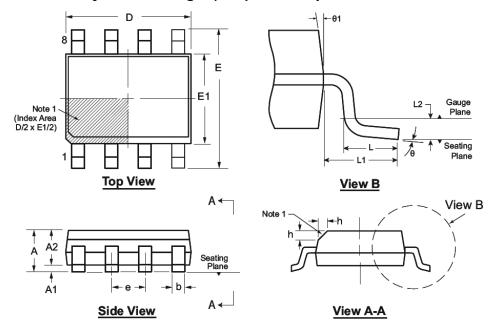


Legend: XX...X Product Code or Customer-specific information
Year code (last digit of calendar year)
YY Year code (last 2 digits of calendar year)
WW Week code (week of January 1 is week '01')
NNN Alphanumeric traceability code
Pb-free JEDEC® designator for Matte Tin (Sn)
* This package is Pb-free. The Pb-free JEDEC designator (e3)
can be found on the outer packaging for this package.

Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for product code or customer-specific information. Package may or not include the corporate logo.

8-Lead SOIC (Narrow Body) Package Outline (LG/TG)

4.90x3.90mm body, 1.75mm height (max), 1.27mm pitch



Note: For the most current package drawings, see the Microchip Packaging Specification at www.microchip.com/packaging.

Note:

 This chamfer feature is optional. A Pin 1 identifier must be located in the index area indicated. The Pin 1 identifier can be: a molded mark/identifier; an embedded metal marker; or a printed indicator.

Sym	bol		Α	A1	A2	b	D	E	E1	е	h	L	L1	L2	θ	θ1
	MIN	1	1.35*	0.10	1.25	0.31	4.80*	5.80*	3.80*		0.25	0.40			0 o	5 °
Dimensio (mm)	NON	1	- [-	-	-	4.90	6.00	3.90	1.27 BSC	-	-	1.04 REF	0.25 BSC	-	-
()	MAX	(1	1.75	0.25	1.65*	0.51	5.00*	6.20*	4.00*	500	0.50	1.27	1 (_ 1	Воо	8º	15°

JEDEC Registration MS-012, Variation AA, Issue E, Sept. 2005.

Drawings are not to scale.

^{*} This dimension is not specified in the JEDEC drawing.



NOTES:

APPENDIX A: REVISION HISTORY

Revision A (March 2017)

- Converted Supertex Doc# DSFP-HV508 to Microchip DS20005728A
- Removed "HVCMOS® Technology" throughout the data sheet
- · Changed part marking format
- Changed the quantity of the 8-lead SOIC LG package from 2500/Reel to 3300/Reel
- Made minor text changes throughout the document

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, contact your local Microchip representative or sales office.

PART NO.	<u>XX</u>		- х - х	Example:	
Device	Packag Options		Environmental Media Type	a) HV508LG-G:	High-Voltage Liquid Crystal Shutter Driver, 8-lead SOIC, 3300/Reel
Device:	HV508	=	High-Voltage Liquid Crystal Shutter Driver		
Package:	LG	=	8-lead SOIC		
Environmental:	G	=	Lead (Pb)-free/RoHS-compliant Package		
Media Type:	(blank)	=	3300/Reel for an LG Package		

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- Microchip is willing to work with the customer who is concerned about the integrity of their code.
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